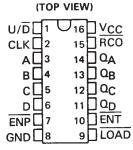
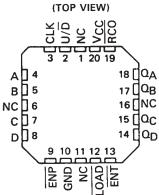
- Programmable Look-Ahead Up/Down
 Binary Counters
- Fully Synchronous Operation for Counting and Programming
- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Fully Independent Clock Circuit

SN54LS169B, SN54S169 . . . J OR W PACKAGE SN74LS169B, SN74S169 . . . D OR N PACKAGE



SN54LS169B, SN54S169 . . . FK PACKAGE



description

These synchronous presettable counters feature an internal carry look-ahead for cascading in high speed counting applications. The 'LS169B and 'S169 are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the countenable inputs and internal gating. This mode of operation helps eliminate the output counting spikes that are normally associated with asynchronous (ripple-clock) counters. A buffered clock input triggers the four master-slave flip-flops on the rising (positive-going) edge of the clock waveform.

These counters are fully programmable; that is the outputs may each be preset to either level. The load input circuitry allows loading with the carry-enable output of cascaded counters. As loading is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the data inputs after the next clock pulse.

NC-No internal connection

| ТҮРЕ | TYPICAL I CLOCK FR | TYPICAL POWER | |
|---------|-----------------------|------------------|-------------|
| | COUNTING UP | COUNTING DOWN | DISSIPATION |
| 'LS169B | 35MHz | 35MHz | 100mW |
| 'S169 | 70MHz | 55MHz | 500mW |

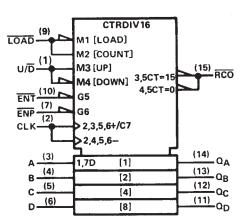
The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable inputs and a carry output. Both count enable inputs (ENP, ENT) must be low to count. The direction of the count is determined by the level of the up/down input. When the input is high, the counter counts up; when low, it counts down. Input ENT is fed forward to enable the carry output. The carry output thus enabled will produce a low-level output pulse with a duration approximately equal to the high portion of the QA output when counting up and approximately equal to the low portion of the QA output when counting down. This low-level overflow carry pulse can be used to enable successive cascaded stages. Transitions at the ENP or ENT inputs are allowed regardless of the level of the clock input. All inputs are diode-clamped to minimize transmission-line effects, thereby simplifying system design.

These counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, LOAD, U/D) that will modify the operating mode have no effect until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) will be dictated solely by the conditions meeting the stable setup and hold times.



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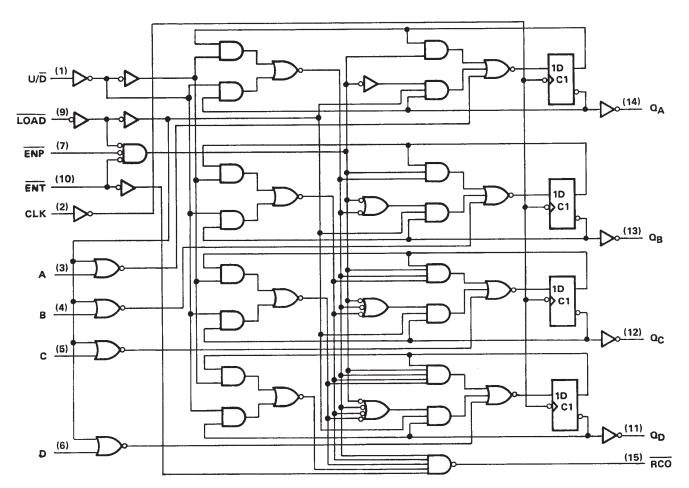
logic symbol[†]



 $^\dagger This$ symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.



logic diagram (positive logic)

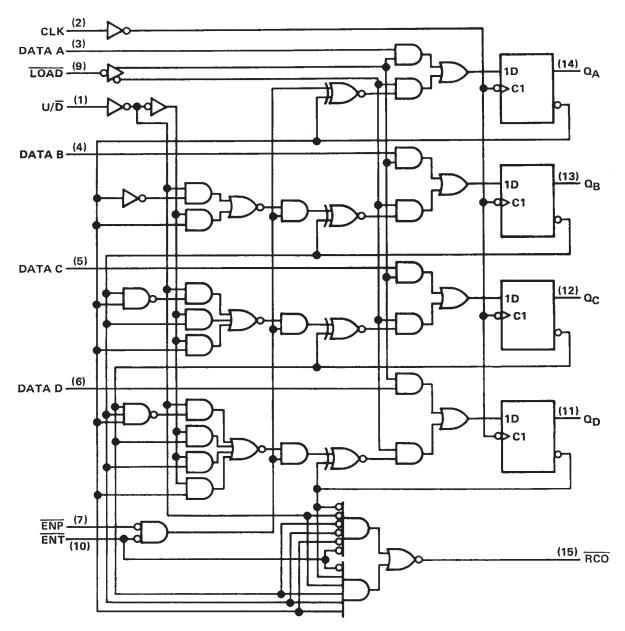


Pin numbers shown are for D, J, N, and W packages.



SN54LS169B, SN54S169 SN74LS169B, SN74S169 SYNCHRONOUS 4-BIT UP/DOWN BINARY COUNTERS SDLS134 - OCTOBER 1976 - REVISED MARCH 1988

logic diagram (positive logic)



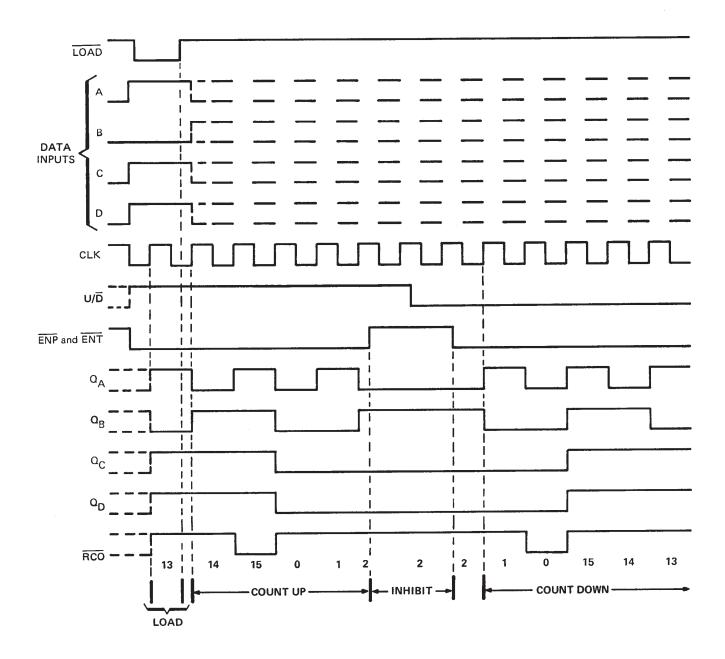
Pin numbers shown are for D, J, N, and W packages.



typical load, count, and inhibit sequences

Illustrated below is the following sequence:

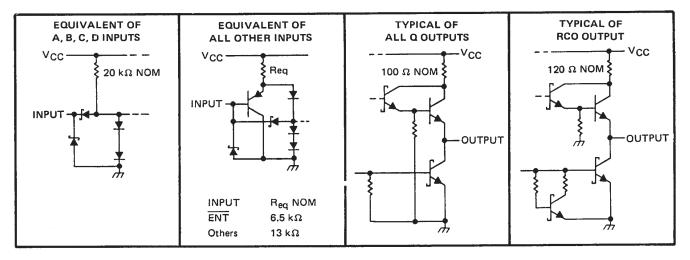
- 1. Load (preset) to binary thirteen.
- 2. Count up to fourteen, fifteen (maximum), zero, one, and two.
- 3. Inhibit
- 4. Count down to one, zero (minimum), fifteen, fourteen, and thirteen





SN54LS169B, SN54S169 SN74LS169B, SN74S169 SYNCHRONOUS 4-BIT UP/DOWN BINARY COUNTERS SDLS134 – OCTOBER 1976 – REVISED MARCH 1988

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| | Input voltage | | 7 V |
|----|--|---------------------|------------|
| | Operating free-air temperature range: | SN54LS169B | to 125°C |
| | | SN74LS169B | 'C to 70°C |
| | Storage temperature range | - 65°C | to 150°C |
| 70 | 1. Volters values are with respect to petw | ork ground terminal | |

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

| | · · · · · · · · · · · · · · · · · · · | | | SI | V54LS1 | 69B | SN74LS169B | | | | |
|-----------------|--|-------------------------------|------------|------|--------|-------|------------|-----|-------|------|--|
| | | | | MIN | NOM | MAX | MIN | NOM | MAX | | |
| Vcc | Supply voltage | | | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V | |
| VIH | High-level-input voltage | | | 2 | | | 2 | | | V | |
| VIL | Low-level input voltage | | | | | 0.7 | | | 0.8 | V | |
| юн | | | RCO | | | - 0.4 | | | - 0.4 | mA | |
| 011 | • | | Any Q | | | - 1.2 | | | - 1.2 | mA | |
| IOL | Low love output output | | RCO | | | 4 | | | 8 | mA | |
| | | | Any Q | | | 12 | | | 24 | mA | |
| fclock | Clock frequency | | | 0 | | 20 | 0 | | 20 | MHz | |
| tw(clock) | Width of clock pulse (high or low) | (see Figure 1) | | 25 | | | 25 | | | ns | |
| | ······································ | Data inputs | A, B, C, D | 30 | | | 30 | | | | |
| | | ENP or ENT | | 30 | | | 30 | | |] _ | |
| t _{su} | Setup time, (see Figure 1) | Load | | 35 | | | 35 | | | - ns | |
| | | U/D | | 35 | | | 35 | | | | |
| t _h | Hold time at any input with respe | spect to clock (see Figure 1) | | 0 | | | 0 | | | ns | |
| TA | Operating free-air temperature | | | - 55 | | 125 | 0 | | 70 | °C | |



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | TEST CONDITIONS [†] | | SN | 154LS16 | 69B | SN | 174LS16 | 69B | UNIT | | |
|-----------|--|------------------------------|-------------------------|----------------------------|------|------------------|---------|------|------|----------|-------|
| PARAMETER | | TEST COND | ITIONS | | MIN | TYP [‡] | MAX | MIN | түр‡ | MAX | |
| VIK | V _{CC} = MIN, | lı = – 18 mA | | | | | - 1.5 | | | - 1.5 | V |
| | V _{CC} = MIN, | V _{IH} = 2 V, | RCO | l _{OH} = - 0.4 mA | 2.5 | 3.4 | | 2.7 | 3.4 | | |
| VOH | VIL = MAX | | Any Q IOH = - 1.2 mA | 2.4 | 3.2 | | 2.4 | 3.2 | | ` | |
| | $V_{OL} \qquad \begin{array}{l} V_{CC} = MIN, V_{IH} = 2V, \\ V_{IL} = MAX \end{array}$ | | RCO | IOH = 4 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| | | $V_{CC} = MIN, V_{IH} = 2V,$ | I NCO | IOL = 8 mA | | | | | 0.35 | 0.5 | |
| VOL | | Any Q | I _{OL} = 12 mA | | 0.25 | 0.4 | | 0.25 | 0.4 |] ` | |
| | | | | IOL = 24 mA | | | | | 0.35 | 0.5 | ļ |
| 1 | V _{CC} = MAX, | V ₁ = 7 V | | | | | 0.1 | | | 0.1 | mA |
| ЧΗ | V _{CC} = MAX, | V ₁ = 2.7 V | | | | | 20 | | | 20 | μA |
| | | | | AD, ENP, CLK | | | - 0.2 | | | - 0.2 | mA |
| ΊL | V _{CC} = MAX, | V ₁ = 0.4 V | All othe | r inputs | | | - 0.4 | | | - 0.4 |] 104 |
| | | | RCO | | - 20 | | - 100 | - 20 | | - 100 | |
| IOS§ | $V_{CC} = MAX, V_O = 0 V$ Any | | Any Q | | - 30 | | - 130 | - 30 | | - 130 | - mA |
| lcc | V _{CC} = MAX, | See Note 2 | | | 1 | 28 | 45 | | 28 | 45 | mA |

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

I + All typical values are at V_{CC} = 5 V, T_A = 25°C.

§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured after applying a momentary 4.5 V, then ground, to the clock input with all other inputs grounded and the outputs open.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 3)

| | FROM | то | ТО | | | UNIT | | | |
|------------------|---------|----------|---|-------------------------|----------|------|-----|-----|----|
| PARAMETER¶ | (INPUT) | (OUTPUT) | TEST CONDITIONS | | | ТҮР | MAX | | |
| fmax | | | | | 20 | 35 | | MHz | |
| tPLH | 01.14 | RCO | | | | 26 | 40 | ns | |
| tPHL | CLK | RCU | | | | 17 | 25 | 113 | |
| tPLH | | RCO | | D - 0 + 0 | 0 15 - 5 | | 15 | 25 | ns |
| tPHL . | ENT | | $\frac{1}{RCO} \qquad R_{L} = 2 k\Omega,$ | С _L = 15 рF | | 11 | 20 | | |
| tPLH | | | | | | 23 | 35 | ns | |
| ^t PHL | U/D | RCO | | | | 15 | 25 | | |
| ^t PLH | | | 0 45 5 | | 16 | 25 | | | |
| ^t PHL | CLK | Any Q | R _L = 667 Ω, | C _L = 45 pF | | 17 | 25 | ns | |

¶ Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (0), the ripple carry output transistion will be in phase. If the count is maximum (15), the ripple carry output will be out of phase.

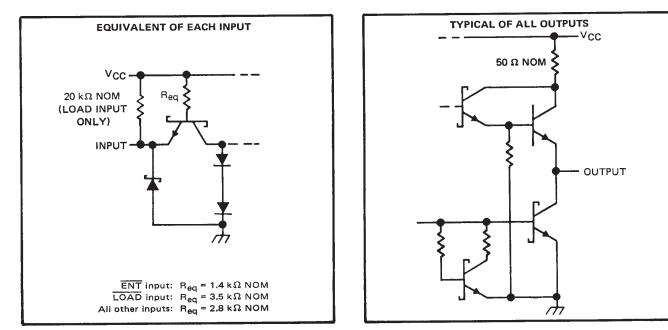
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN54LS169B, SN54S169 SN74LS169B, SN74S169 SYNCHRONOUS 4-BIT UP/DOWN BINARY COUNTERS SDLS134 – OCTOBER 1976 – REVISED MARCH 1988

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schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V _{CC} (See Note 4) | 7 V |
|---|---------------|
| Input voltage | |
| Interemitter voltage (see Note 5) | |
| Operating free-air temperature range: SN54S169 (see Note 6) | 55°C to 125°C |
| SN74S169 | |
| Storage temperature range | 65°C to 150°C |

recommended operating conditions

| | | SN54S169 | | SN74S169 | | | UNIT | | |
|---|----------------------------|----------|-----|----------|------|-----|------|----|--|
| | | MIN | NOM | MAX | MIN | NOM | MAX | | |
| Supply voltage, V _{CC} | | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V | |
| High-level output current, IOH | | | | - 1 | | | 1 | mA | |
| Low-level output current, IOL | | | | 20 | | | 20 | mA | |
| Clock frequency, fclock | 0 | | 40 | 0 | | 40 | мн | | |
| Width of clock pulse, tw(clock) (high | or low) (see Figure 1) | 10 | | | 10 | | | ns | |
| | Data inputs A, B, C, D | 4 | | | 4 | | | | |
| | ENP or ENT | 14 | | | 14 | | | ns | |
| Setup time,t _{SU} (see Figure 1) | Load | 9 | | | 6 | | | | |
| | U/D | 20 | | | 20 | | | | |
| Hold time at any input with respect to | o clock, tw (see Figure 1) | 1 | | | 1 | | | ns | |
| Operating free-air temperature, T _A (see Note 6) | | - 55 | | 125 | 0 | | 70 | °C | |

NOTES: 4. Voltage values, except interemitter voltage, are with respect to network ground terminal.

- 5. This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the count enable inputs ENP and ENT.
- A SN54S169 in the W package operating at free-air temperatures above 91 °C requires a heat sink that provides a thermal resistance from case to free-air, R_{θCA}, of not more than 26 °C/W.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | | | SN54S169 | | | SN74S169 | | | |
|---|--------------|--------------------------------------|---|----------|------------------|-------|----------|------|-------|------|
| | | TEST CO | TEST CONDITIONS [†] | | TYP [‡] | MAX | MIN | түр‡ | MAX | UNIT |
| VIH High-level input voltage | | | | 2 | | | 2 | | | V |
| VII Low-level input voltage | | | | | | 0.8 | | | 0.8 | V |
| VIK Input clamp voltage | | $V_{CC} = MIN,$ | $I_{I} = -18 \text{ mA}$ | | | - 1.2 | | | - 1.2 | V |
| V _{OH} High-level output voltage | | $V_{CC} = MIN,$ $V_{IL} = 0.8 V,$ | $V_{IH} = 2 V,$ $I_{OH} = -1 mA$ | 2.5 | 3.4 | | 2.7 | 3.4 | | v |
| V _{OL} Low-level output voltage | | $V_{CC} = MIN,$ $V_{IL} = 0.8 V,$ | V _{IH} = 2 V, I _{OL} = 20 mA | | | 0.5 | | | 0.5 | v |
| I Input current at maximum in | put voltage | $V_{CC} = MAX,$ | V ₁ = 5.5 V | | | 1 | | | 1 | mA |
| | ENT | | | | | 100 | | | 100 | |
| I _{IH} High-level input current | Load | $V_{CC} = MAX,$ | $V_{i} = 2.7 V$ | - 10 | | - 200 | - 10 | | - 200 | μA |
| | Other inputs | | | | | 50 | | | 50 | |
| | ENT | | | | | - 4 | | | -4 | - mA |
| IIL Low-level input current | Other inputs | $V_{\rm CC} = MAX,$ | $V_{1} = 0.5 V$ | | | - 2 | | | - 2 | |
| IOS Short-circuit output current§ | • | $V_{CC} = MAX,$ | | - 40 | | - 100 | - 40 | | - 100 | mA |
| ICC Supply current | | V _{CC} = MAX, | See Note 2 | | 100 | 160 | | 100 | 160 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25 °C.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured after applying a momentary 4.5 V, then ground, to the clock input with all other inputs grounded and the outputs open.

| | FROM | TO | TEST CONDITIONS | | U/D = HIGH | | | $U/\overline{D} = LOW$ | | |
|-------------------|---------|----------|---|---------------------|------------|-----|-----|------------------------|-----|------|
| PARAMETER | (INPUT) | (OUTPUT) | TEST CONDITIONS | MIN | ТҮР | MAX | MIN | түр | MAX | UNIT |
| f _{max} | | | | 40 | 70 | | 40 | 55 | | MHz |
| tPLH | 01.14 | RCO | | | 14 | 21 | | 14 | 21 | ns |
| tPHL | CLK | RCO | 0 15 5 | | 20 | 28 | | 20 | 28 | |
| tPLH | 01.14 | Any Q | $C_{L} = 15 pF,$ $R_{L} = 280 \Omega,$ | | 8 | 15 | | 8 | 15 | ns |
| tPHL | CLK | | | See Figures 2 and 3 | | 11 | 15 | | 11 | 15 |
| tPLH | | | and Note 3 | | 7.5 | 11 | | 6 | 12 | |
| tPHL | ENT | ENI RCO | | | 15 | 22 | | 15 | 25 | ns |
| tPLH [¢] | | RCO | RCO | | 9 | 15 | | 8 | 15 | |
| tPHL≎ | | | | | 10 | 15 | | 16 | 22 | ns |

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

1 tmax = maximum clock frequency

tpLH = propagation delay time, low-to-high-level output

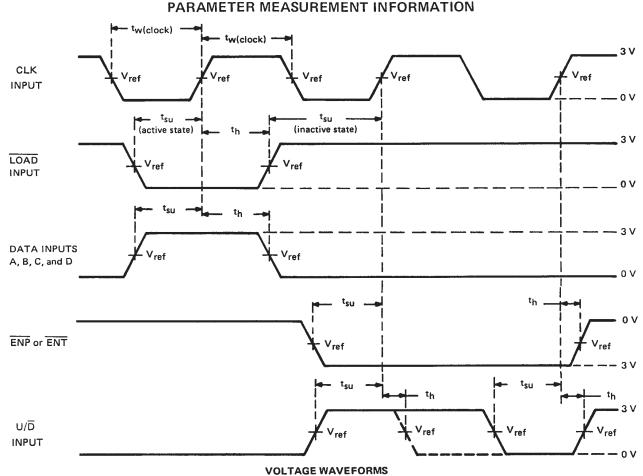
tpHL = propagation delay time, high-to-low-level output

Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (O), the ripple carry output transition will be in phase. If the count is maximum (15 for 'S169), the ripple carry output will be out of phase.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

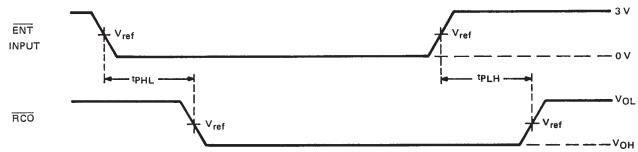


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- NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, Z_{out} \approx 50 Ω ; for 'LS169B, t_r \leq 15 ns; t_f \leq 6 ns, and for 'S169, t_r \leq 2.5 ns, t_f \leq 2.5 ns.
 - B. For 'LS169B, V_{ref} = 1.3 V; for 'S168 and 'S169, V_{ref} = 1.5 V.

FIGURE 1-PULSE WIDTHS, SETUP TIMES, HOLD TIMES



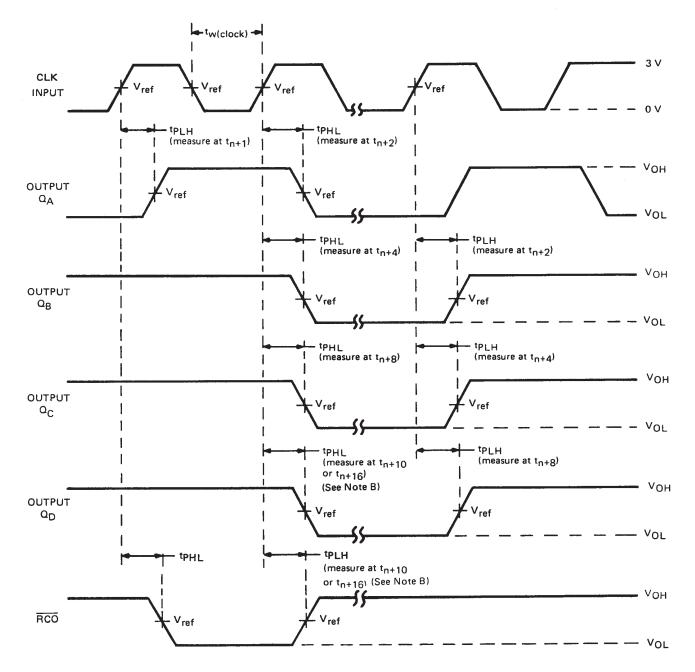
VOLTAGE WAVEFORMS

- NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR ≤ MHz, duty cycle ≤ 50%, Z_{out} ≈ 50 Ω; for 'LS169B, t_r ≤ 15 ns, t_f ≤ 5 ns; and for 'S169, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
 - B. tpLH and tpHL from enable T input to ripple carry output assume that the counter is at the maximum count, all Q outputs high. C. For 'LS169B, $V_{ref} = 1.3 V$; for 'S169, $V_{ref} = 1.5 V$.
 - D. Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (0) the ripple carry output transition will be in phase. If the count is maximum (15), the ripple carry output will be out of phase.

FIGURE 2-PROPAGATION DELAY TIMES TO CARRY OUTPUT



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PARAMETER MEASUREMENT INFORMATION

UP-COUNT VOLTAGE WAVEFORMS

NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR < 1 MHz, duty cycle <50%, $Z_{out} \approx 50 \ \Omega$; for 'LS169B, $t_r \le 15 \ \text{ns}$; $t_f \le 6 \ \text{ns}$, and 'S169, $t_r \le 2.5 \ \text{ns}$, $t_f \le 2.5 \ \text{ns}$. Vary PRR to measure f_{max} .

- B. Outputs Q_D and carry are tested at t_{n+16} , where t_n is the bit-time when all outputs are low. C. For 'LS169B, $V_{ref} = 1.3 V$; for 'S169, $V_{ref} = 1.5 V$.

FIGURE 3-PROPAGATION DELAY TIMES FROM CLOCK



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| Interface | interface.ti.com | Digital Control | www.ti.com/digitalcontrol |
| Logic | logic.ti.com | Military | www.ti.com/military |
| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
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| Interface | interface.ti.com | Digital Control | www.ti.com/digitalcontrol |
| Logic | logic.ti.com | Military | www.ti.com/military |
| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers | microcontroller.ti.com | Security | www.ti.com/security |
| Low Power Wireless | www.ti.com/lpw | Telephony | www.ti.com/telephony |
| | | Video & Imaging | www.ti.com/video |
| | | Wireless | www.ti.com/wireless |

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| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers | microcontroller.ti.com | Security | www.ti.com/security |
| Low Power Wireless | www.ti.com/lpw | Telephony | www.ti.com/telephony |
| | | Video & Imaging | www.ti.com/video |
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9-Oct-2007

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 80018022A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| 8001802EA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 8001802EA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 8001802FA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| 8001802FA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| SN54LS169BJ | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SN54LS169BJ | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SN54S169J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SN54S169J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SN74LS169BD | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BD | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BDE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BDE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BDG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BDG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BN | ACTIVE | PDIP | Ν | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74LS169BN | ACTIVE | PDIP | Ν | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74LS169BNE4 | ACTIVE | PDIP | Ν | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74LS169BNE4 | ACTIVE | PDIP | Ν | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74LS169BNSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BNSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BNSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BNSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BNSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LS169BNSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74S169J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI |
| SN74S169J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI |
| SN74S169N | OBSOLETE | PDIP | Ν | 16 | | TBD | Call TI | Call TI |
| SN74S169N | OBSOLETE | PDIP | Ν | 16 | | TBD | Call TI | Call TI |
| SN74S169N3 | OBSOLETE | PDIP | Ν | 16 | | TBD | Call TI | Call TI |
| SN74S169N3 | OBSOLETE | PDIP | Ν | 16 | | TBD | Call TI | Call TI |



| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| SNJ54LS169BFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54LS169BFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54LS169BJ | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SNJ54LS169BJ | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SNJ54LS169BW | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54LS169BW | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54S169FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54S169FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54S169J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SNJ54S169J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SNJ54S169W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54S169W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



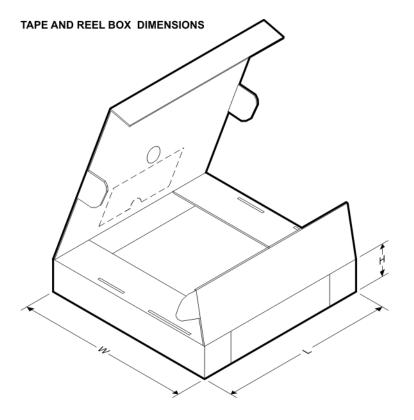
| *All dimensions are nominal | |
|-----------------------------|--|
| | |

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74LS169BNSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS169BNSR | SO | NS | 16 | 2000 | 346.0 | 346.0 | 33.0 |

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AC.



D(R-PDSO-G16)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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